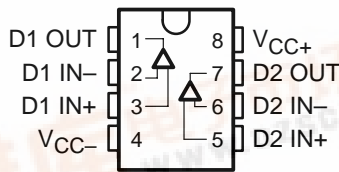
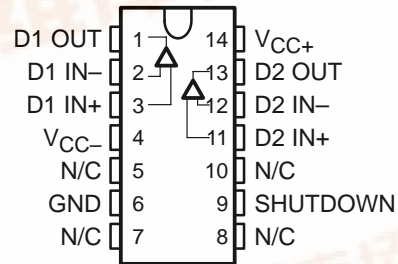


- **Remote Terminal ADSL Line Driver**
 - Ideal for Both Full Rate ADSL and G.Lite
 - Compatible With 1:1 Transformer Ratio
- **Low 2.7 pA/√Hz Noninverting Current Noise**
 - Reduces Noise Feedback Through Hybrid Into Downstream Channel
- **Wide Supply Voltage Range ±5 V to ±15 V**
 - Ideal for ±12-V Operation
- **Wide Output Swing**
 - 42 Vpp Differential Output Voltage, $R_L = 200 \Omega$, ±12-V Supply
- **High Output Current**
 - 175 mA (typ)
- **High Speed**
 - 110 MHz (–3 dB, $G=8$, ±12 V)
 - 1500 V/μs Slew Rate ($G = 8$, ±12 V)
- **Low Distortion, Single-Ended, $G = 8$**
 - –83 dBc (250 kHz, 2 Vpp, 100-Ω load)
- **Low Power Shutdown (THS6053)**
 - 300-μA Total Standby Current
- **Thermal Shutdown and Short Circuit Protection**
- **Standard SOIC, SOIC PowerPAD, and TSSOP PowerPAD™ Package**
- **Evaluation Module Available**

THS6052
SOIC (D) AND
SOIC PowerPAD™ (DDA) PACKAGE
(TOP VIEW)

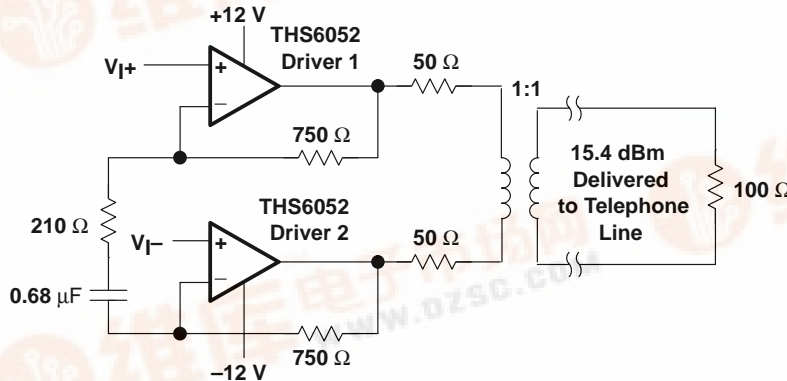


THS6053
SOIC (D) AND
TSSOP PowerPAD™ (PWP) PACKAGE
(TOP VIEW)



description

The THS6052/3 is a high-speed line driver ideal for driving signals from the remote terminal to the central office in asymmetrical digital subscriber line (ADSL) applications. It can operate from ±12-V supply voltages while drawing only 5.2 mA of supply current per channel. It offers low –83 dBc total harmonic distortion driving a 100-Ω load (2 Vpp). The THS6052/3 offers a high 42-Vpp differential output swing across a 200-Ω load from a ±12-V supply. The THS6053 features a low-power shutdown mode, consuming only 300 μA quiescent current per channel. The THS6052/3 is packaged in a standard SOIC, SOIC PowerPAD™, and TSSOP PowerPAD™ packages.



RELATED PRODUCTS

DEVICE	DESCRIPTION
THS6042/3	350-mA, ±12V ADSL CPE line driver
THS6092/3	275-mA, +12 V ADSL CPE line driver
OPA2677	380-mA, +12 V ADSL CPE line driver
THS6062	Low noise ADSL receiver

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerPAD is a trademark of Texas Instruments.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

THS6052, THS6053 175 mA, ±12 V ADSL CPE LINE DRIVERS

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AVAILABLE OPTION

T _A	PACKAGED DEVICE				EVALUATION MODULES
	SOIC-8 (D)	SOIC-8 PowerPAD (DDA)	SOIC-14 (D)	TSSOP-14 (PWP)	
0°C to 70°C	THS6052CD	THS6052CDDA	THS6053CD	THS6053CPWP	THS6052EVM THS6053EVM
-40°C to 85°C	THS6052ID	THS6052IDDA	THS6053ID	THS6053IPWP	—

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage, V _{CC+} to V _{CC-}	33 V
Input voltage	± V _{CC}
Output current (see Note 1)	275 mA
Differential input voltage	± 4 V
Maximum junction temperature	150°C
Total power dissipation at (or below) 25°C free-air temperature	See Dissipation Ratings Table
Operating free-air temperature, T _A : Commercial	0°C to 70°C
Industrial	-40°C to 85°C
Storage temperature, T _{stg} : Commercial	-65°C to 125°C
Industrial	-65°C to 125°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	300°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The THS6052 and THS6053 may incorporate a PowerPAD™ on the underside of the chip. This acts as a heatsink and must be connected to a thermally dissipating plane for proper power dissipation. Failure to do so may result in exceeding the maximum junction temperature which could permanently damage the device. See TI technical brief SLMA002 for more information about utilizing the PowerPAD™ thermally enhanced package.

DISSIPATION RATING TABLE

PACKAGE	θ _{JA}	θ _{JC}	T _A = 25°C T _J = 150°C POWER RATING
D-8	95°C/W‡	38.3°C/W‡	1.32 W
DDA	45.8°C/W‡	9.2°C/W‡	2.73 W
D-14	66.6°C/W‡	26.9°C/W‡	1.88 W
PWP	37.5°C/W	1.4°C/W	3.3 W

‡ This data was taken using the JEDEC proposed high-K test PCB. For the JEDEC low-K test PCB, the θ_{JA} is 168°C/W for the D-8 package and 122.3°C/W for the D-14 package.

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC+} to V _{CC-}	Dual supply	±5		±15	V
	Single supply	10		30	
Operating free-air temperature, T _A	C-suffix	0		70	°C
	I-suffix	-40		85	

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electrical characteristics over recommended operating free-air temperature range, $T_A = 25^\circ\text{C}$, $V_{CC} = \pm 12\text{ V}$, $R_{\text{FEEDBACK}} = 750\ \Omega$, $R_L = 100\ \Omega$ (unless otherwise noted)

dynamic performance

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
BW	Small-signal bandwidth (–3 dB)	$R_L = 50\ \Omega$	G= 1, $R_F = 1\ \text{k}\Omega$	$V_{CC} = \pm 5\ \text{V}$	110		MHz
				$V_{CC} = \pm 12\ \text{V}$	120		
			G= 2, $R_F = 680\ \Omega$	100			
				G= 8, $R_F = 330\ \Omega$	$V_{CC} = \pm 5\ \text{V}, \pm 12\ \text{V}$		
		$R_L = 100\ \Omega$	G= 1, $R_F = 1\ \text{k}\Omega$		$V_{CC} = \pm 5\ \text{V}$	150	
				$V_{CC} = \pm 12\ \text{V}$	170		
			G= 2, $R_F = 680\ \Omega$	135			
				G= 8, $R_F = 330\ \Omega$	$V_{CC} = \pm 5\ \text{V}, \pm 12\ \text{V}$		
SR	Slew rate (see Note 2), G=8	$V_O = 4\ \text{V}_{PP}$	$V_{CC} = \pm 5\ \text{V}$		$V_{CC} = \pm 5\ \text{V}$	650	
			$V_{CC} = \pm 12\ \text{V}$	$V_{CC} = \pm 12\ \text{V}$	850		
			$V_{CC} = \pm 15\ \text{V}$	$V_{CC} = \pm 15\ \text{V}$	950		
		$V_O = 16\ \text{V}_{PP}$	$V_{CC} = \pm 12\ \text{V}$	$V_{CC} = \pm 12\ \text{V}$	1500		
			$V_{CC} = \pm 15\ \text{V}$	$V_{CC} = \pm 15\ \text{V}$	1700		
				$V_{CC} = \pm 15\ \text{V}$	$V_{CC} = \pm 15\ \text{V}$	1700	

NOTE 2: Slew rate is defined from the 25% to the 75% output levels.

noise/distortion performance

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
THD	Total harmonic distortion (single-ended configuration)	Gain = 8, $R_L = 100\ \Omega$, $V_{CC} = \pm 12\ \text{V}$, $f = 250\ \text{kHz}$	$V_O(pp) = 2\ \text{V}$	–83		dBc	
			$V_O(pp) = 16\ \text{V}$	–78			
		Gain = 8, $R_L = 50\ \Omega$, $V_{CC} = \pm 5\ \text{V}$, $f = 250\ \text{kHz}$	$V_O(pp) = 2\ \text{V}$	–74			
			$V_O(pp) = 6\ \text{V}$	–72			
V_n	Input voltage noise	$V_{CC} = \pm 5\ \text{V}, \pm 12\ \text{V}$, $f = 10\ \text{kHz}$		2.1		nV/ $\sqrt{\text{Hz}}$	
I_n	Input current noise	+Input	$f = 10\ \text{kHz}$, $V_{CC} = \pm 5\ \text{V}$, $V_{CC} = \pm 12\ \text{V}$, $V_{CC} = \pm 15\ \text{V}$	2.7		pA/ $\sqrt{\text{Hz}}$	
		–Input		10.7			
X_T	Crosstalk	$f = 250\ \text{kHz}$, G = 2, $V_{CC} = \pm 12\ \text{V}$, $R_L = 100\ \Omega$	$V_O = 2\ \text{V}_{p-p}$	–79		dBc	
		$f = 250\ \text{kHz}$, G = 2, $V_{CC} = \pm 5\ \text{V}$, $R_L = 50\ \Omega$	$V_O = 2\ \text{V}_{p-p}$	–71			

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175 mA, ± 12 V ADSL CPE LINE DRIVERS

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electrical characteristics over recommended operating free-air temperature range, $T_A = 25^\circ\text{C}$, $V_{CC} = \pm 12$ V, $R_{FEEDBACK} = 750 \Omega$, $R_L = 100 \Omega$ (unless otherwise noted) (continued)

dc performance

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT	
V_{OS}	Input offset voltage	$V_{CC} = \pm 12$ V, $V_{CC} = \pm 6$ V	$T_A = 25^\circ\text{C}$		5	10	mV	
			$T_A = \text{full range}$			15		
	Differential offset voltage		$T_A = 25^\circ\text{C}$		3	6		
	$T_A = \text{full range}$					8		
	Offset drift		$T_A = 25^\circ\text{C}$				30	$\mu\text{V}/^\circ\text{C}$
	$T_A = \text{full range}$							
I_{IB}	– Input bias current	$V_{CC} = \pm 12$ V, $V_{CC} = \pm 6$ V	$T_A = 25^\circ\text{C}$		5	10	μA	
			$T_A = \text{full range}$			12		
	+ Input bias current		$T_A = 25^\circ\text{C}$		2	5		
			$T_A = \text{full range}$			6		
	Differential input bias current		$T_A = 25^\circ\text{C}$		5	10		
	$T_A = \text{full range}$					12		
Z_{OL}	Open loop transimpedance	$V_{CC} = \pm 12$ V, $V_{CC} = \pm 6$ V	$R_L = 1 \text{ k}\Omega$,		1		$\text{M}\Omega$	

input characteristics

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
V_{ICR}	Input common-mode voltage range	$V_{CC} = \pm 12$ V		± 9.7	± 10.1		V
		$V_{CC} = \pm 6$ V		± 3.8	± 4.2		
CMRR	Common-mode rejection ratio	$V_{CC} = \pm 12$ V, $V_{CC} = \pm 6$ V	$T_A = 25^\circ\text{C}$	59	66		dB
			$T_A = \text{full range}$	57			
R_I	Input resistance	+ Input			1.5		$\text{M}\Omega$
		– Input			15		Ω
C_I	Input capacitance				2		pF

output characteristics

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
V_O	Output voltage swing	Single ended	$R_L = 50 \Omega$, $V_{CC} = \pm 6$ V	± 4.2	± 4.6		V
			$R_L = 100 \Omega$	$V_{CC} = \pm 12$ V	± 10.1	± 10.5	
				$V_{CC} = \pm 6$ V	± 4.4	± 4.8	
I_O	Output current	$R_L = 25 \Omega$, $V_{CC} = \pm 12$ V	150	175		mA	
		$R_L = 10 \Omega$, $V_{CC} = \pm 6$ V	150	175			
I_{SC}	Short-circuit current	$R_L = 0 \Omega$, $V_{CC} = \pm 12$ V		250		mA	
	Output resistance	Open loop			14		Ω

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175 mA, ±12 V ADSL CPE LINE DRIVERS

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electrical characteristics over recommended operating free-air temperature range, $T_A = 25^\circ\text{C}$, $V_{CC} = \pm 12\text{ V}$, $R_{\text{FEEDBACK}} = 750\ \Omega$, $R_L = 100\ \Omega$ (unless otherwise noted) (continued)

power supply

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{CC}	Operating range	Dual supply	±4.5		±16.5	V
		Single supply	9		33	
I_{CC}	Quiescent current (each driver)	$V_{CC} = \pm 12\text{ V}$	$T_A = 25^\circ\text{C}$	5.2	7	mA
			$T_A = \text{full range}$		8	
		$V_{CC} = \pm 6\text{ V}$	$T_A = 25^\circ\text{C}$	4.5	6.5	
			$T_A = \text{full range}$		7.5	
PSRR	Power supply rejection ratio	$V_{CC} = \pm 12\text{ V}$	$T_A = 25^\circ\text{C}$	-64	-62	dB
			$T_A = \text{full range}$	-61	-	
		$V_{CC} = \pm 6\text{ V}$	$T_A = 25^\circ\text{C}$	-60	-70	
			$T_A = \text{full range}$	-58		

shutdown characteristics (THS6053 only)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{IL}(\text{SHDN})$	Shutdown pin voltage for power up	$V_{CC} = \pm 6\text{ V}, \pm 12\text{ V}$, GND = 0 V, (GND Pin as Reference)			0.8	V
$V_{IH}(\text{SHDN})$	Shutdown pin voltage for power down	$V_{CC} = \pm 6\text{ V}, \pm 12\text{ V}$, GND = 0 V, (GND Pin as Reference)	2			V
$I_{CC}(\text{SHDN})$	Total quiescent current when in shutdown state	$V_{GND} = 0\text{ V}, V_{CC} = \pm 6\text{ V}, \pm 12\text{ V}$		0.3	0.7	mA
t_{DIS}	Disable time (see Note 3)	$V_{CC} = \pm 12\text{ V}$		0.1		μs
t_{EN}	Enable time (see Note 3)	$V_{CC} = \pm 12\text{ V}$		0.4		μs
$I_{IL}(\text{SHDN})$	Shutdown pin input bias current for power up	$V_{CC} = \pm 6\text{ V}, \pm 12\text{ V}$		40	100	μA
$I_{IH}(\text{SHDN})$	Shutdown pin input bias current for power down	$V_{CC} = \pm 6\text{ V}, \pm 12\text{ V}$, $V(\text{SHDN}) = 3.3\text{ V}$		50	100	μA

NOTE 3: Disable/enable time is defined as the time from when the shutdown signal is applied to the SHDN pin to when the supply current has reached half of its final value.

THS6052, THS6053 175 mA, ± 12 V ADSL CPE LINE DRIVERS

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APPLICATION INFORMATION

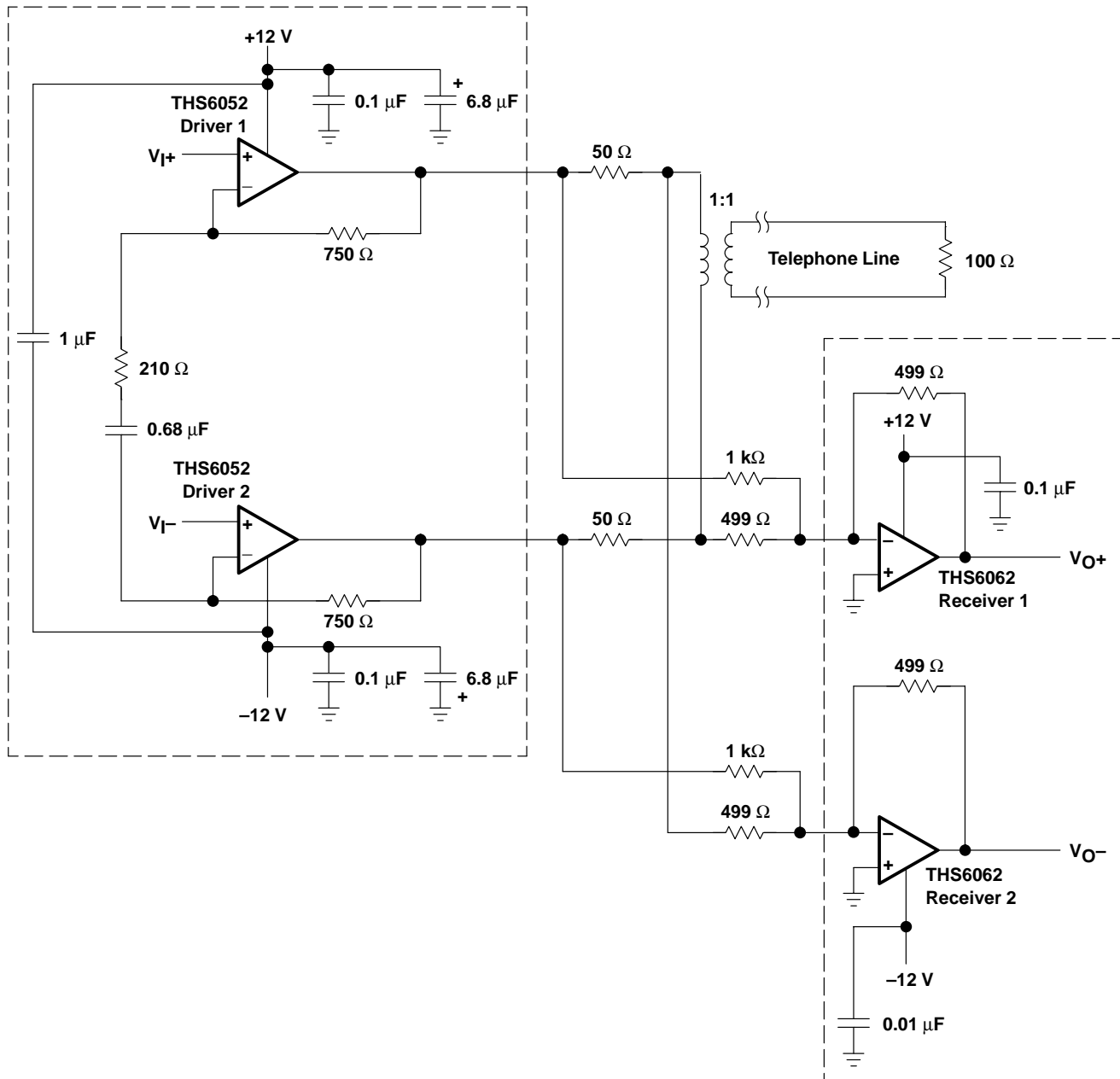


Figure 1. THS6052 ADSL Application With 1:1 Transformer Ratio

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175 mA, ±12 V ADSL CPE LINE DRIVERS

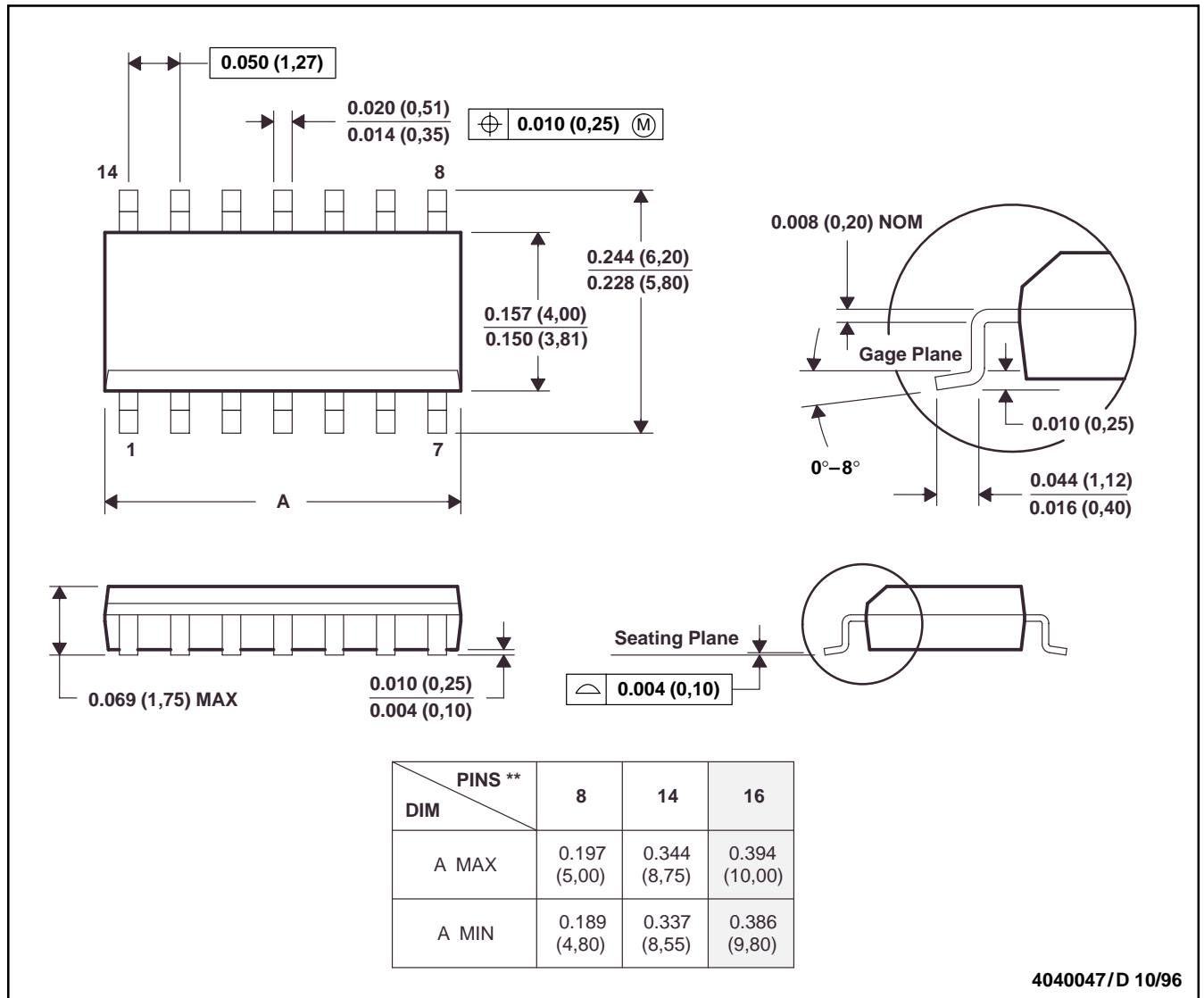
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MECHANICAL DATA

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-012

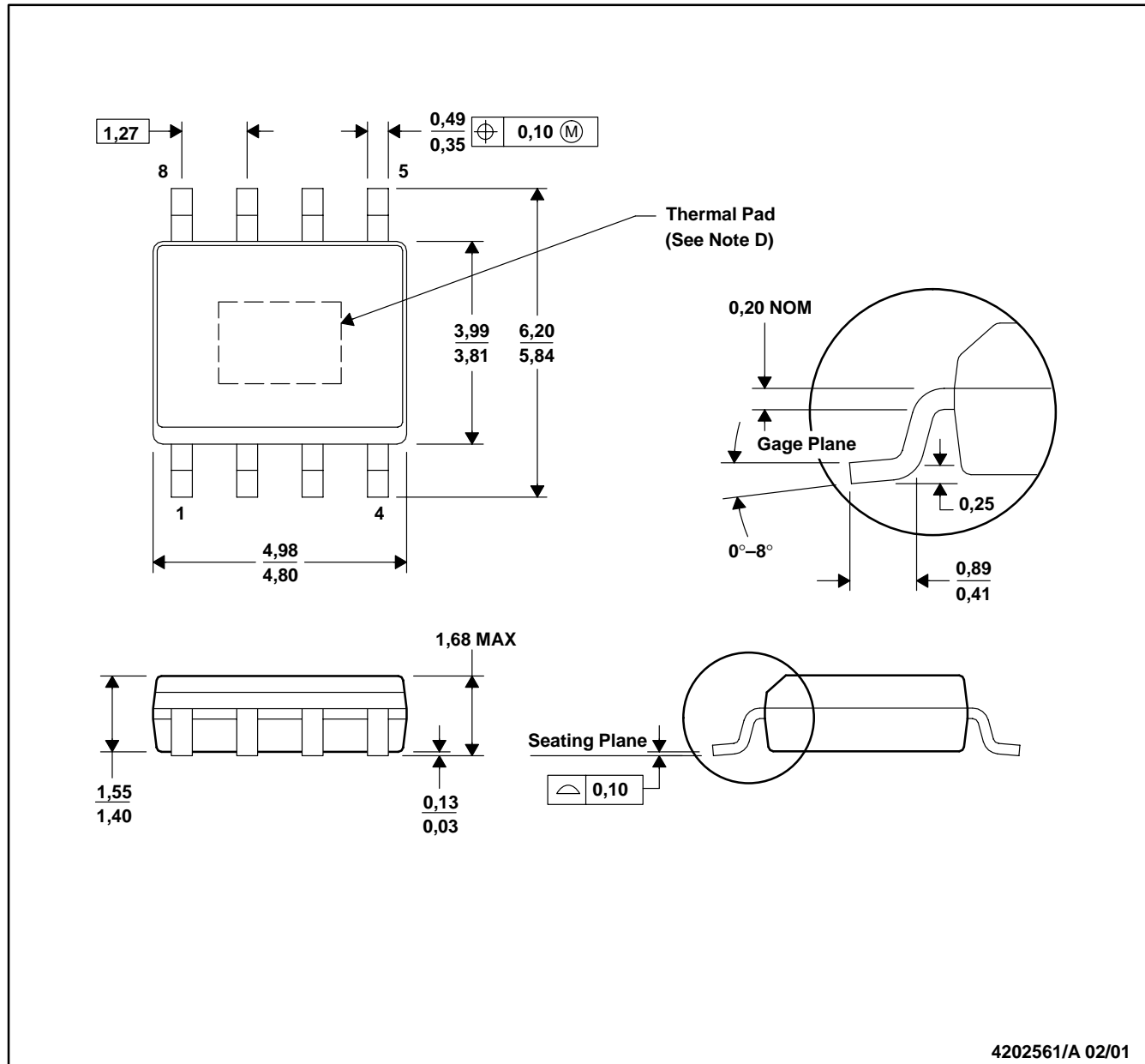
THS6052, THS6053 175 mA, ±12 V ADSL CPE LINE DRIVERS

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MECHANICAL DATA

DDA (S-PDSO-G8)

Power PAD™ PLASTIC SMALL-OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - The package thermal performance may be enhanced by bonding the thermal pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected leads.

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THS6052, THS6053
175 mA, ±12 V ADSL CPE LINE DRIVERS

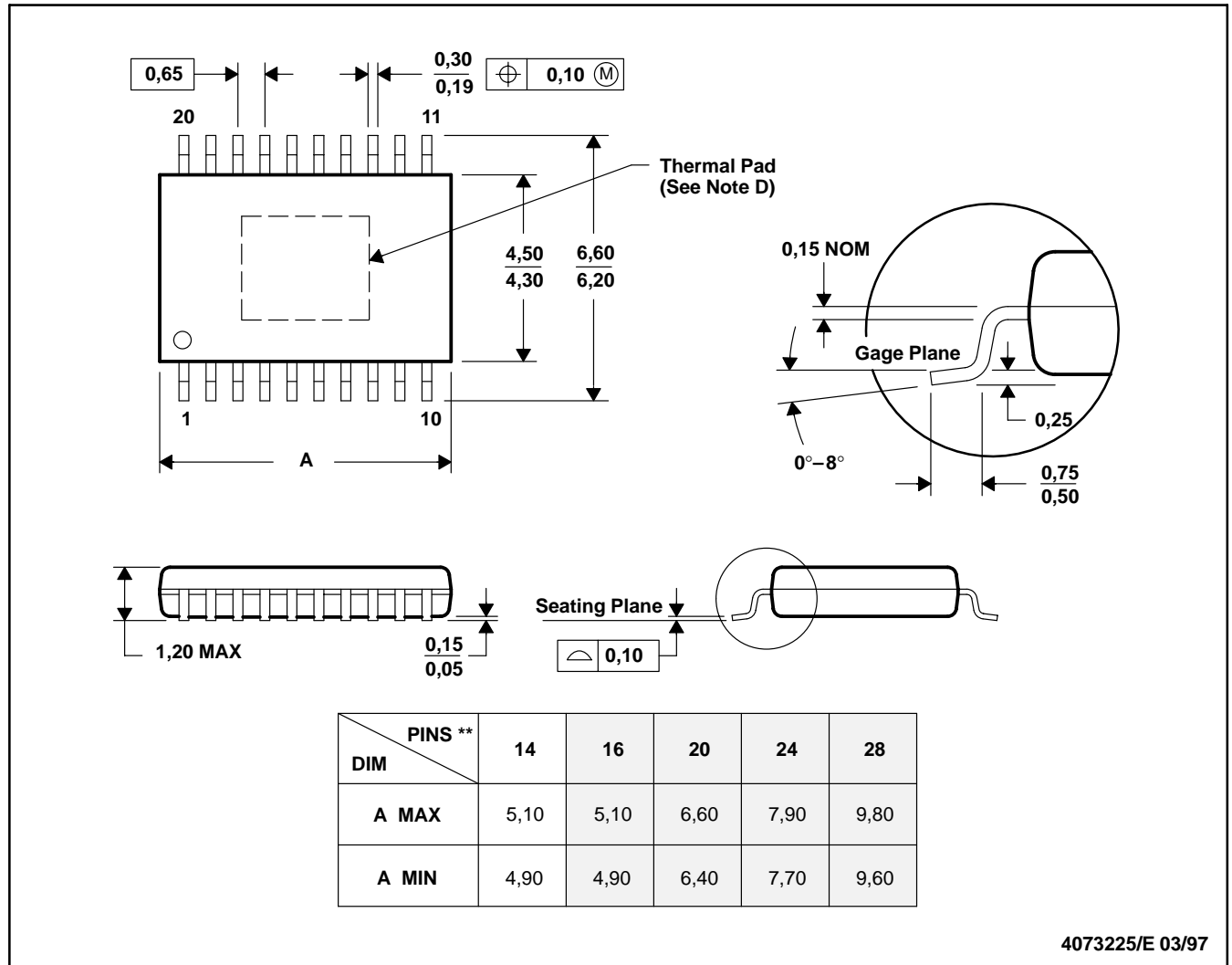
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MECHANICAL INFORMATION

PWP (R-PDSO-G**)

PowerPAD™ PLASTIC SMALL-OUTLINE PACKAGE

20-PIN SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusions.
 D. The package thermal performance may be enhanced by bonding the thermal pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected leads.
 E. Falls within JEDEC MO-153

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